

Data Sheet 159.5MHz SAW 5050 SPT159M5050A

V1.0

Description:

The Spectron SPT159M5050A is a SAW filter that work frequency ranges from156.5MHz to 162.5MHz.It is designed for applications in wireless module and Information& Communications filed.

The SPT159M5050A provides +20 dBm power handling, low insertion loss and high out of band rejection.

The design and manufacturing of the SPT159M5050A exploit Spectron's exclusive TSAW technology to deliver competitive performance against state of the art at a low cost.

The SPT159M5050A is compatible with high volume, lead-free SMT soldering processes.

Features:

- Single-Ended Input and Output
- Terminating Impedance: 50 Ω
- RoHS Compliant
- Package size 5.00x5.00x1.50mm3

Specifications:

- Operation Temperature:-40°C to +85°C
- Low-loss SAW component
- Low amplitude ripple
- Sharp rejections at both out-bands
- Usable passband 6 MHz
- 3dB bandwidth TYP 11MHz

Applications:

- Information& Communications Devices
- Wireless module

Electrical Specifications

Table 1 Electrical Specifications.

Item		Minimum	Typical	Maximum	Unit
Center Frequency	fc		159.5		MHz
Insertion Loss @159.50 MHz	IL		2.2	3.5	dB
Insertion Loss 156.50 – 162.50 MHz	IL		3.1	4.5	dB
Amplitude Ripple (p-p) 156.50 – 162.50 MHz	∆a		1.4	2.0	dB
-3dB Bandwidth	BW _{3dB}	8.0	11.0		MHz
Absolute Attenuation	a				
DC - 113.70 MHz		50.0	55.0		dB
113.70 - 119.70 MHz		50.0	55.0		dB
199.30 - 205.30 MHz		40.0	45.0		dB
205.30 - 1000.00 MHz		35.0	40.0		dB

1. Min/Max specifications are guaranteed at the indicated temperature (unless otherwise noted).

2. Typical data is the average value (arithmetic mean) of the parameter over the indicated band at +25°C

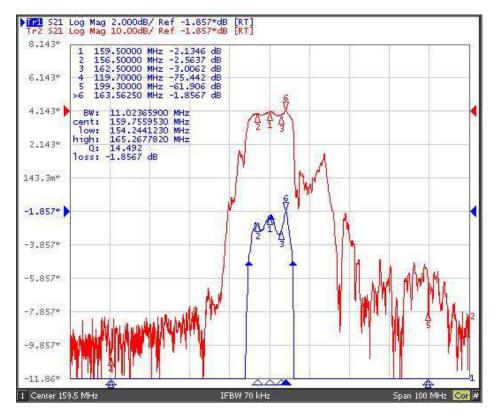
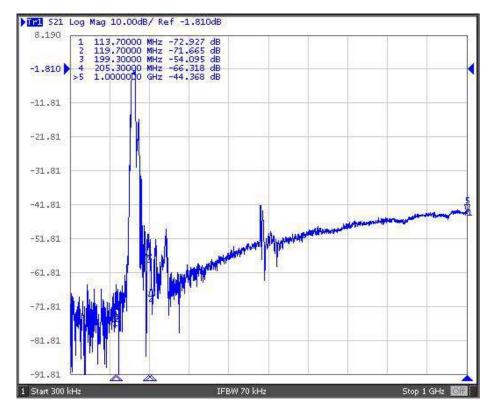
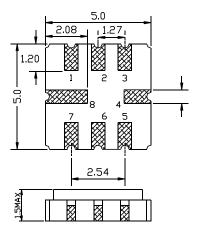


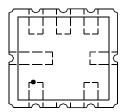
Figure 1 Electrical Characteristics: Frequency response.



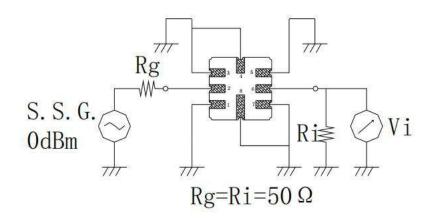
Package & Dimensions



Pin No.	Description
2	Input
6	Output
1,3,4,5,7,8	Ground



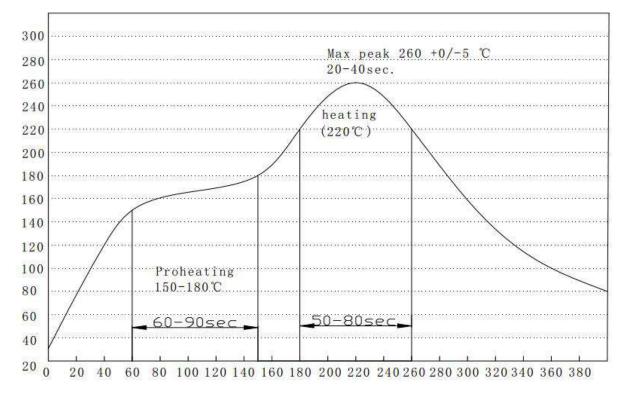
Test circuit



Maximum Ratings

Item		Value	Unit
Operation Temperature	т	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +125	°C
RF Power Dissipation	Р	20	dBm

Recommended SMT Solder Profile



0	rdering Information		
	Part Number	Number of Devices	Container
	SPT159M5050A	1000pcs	Tape and Reel

Reliability

No.	Test item	Test condition	
1	Temperature Storage	Temperature: $85^{\circ}C\pm 2^{\circ}C$, Duration: 250h, Recovery time: $2h\pm 0.5h$ (2) Temperature: $-55^{\circ}C\pm 3^{\circ}C$, Duration: 250h, Recovery time: $2h\pm 0.5h$	
2	Humidity Test	Conditions: 60°C±2°C ,90~95% RH Duration: 250h	
3	Thermal Shock	Heat cycle conditions: TA=-55°C±3°C, TB=85°C±2°C, t1=t2=30min, Switch time: ≤3min, Cycle time: 100 times, Recovery time: 2h±0.5h.	
4	Vibration Fatigue	Frequency of vibration: 10~55HzAmplitude:1.5mmDirections: X,Y and ZDuration: 2h	
5	Drop Test	Cycle time: 10 times Height: 1.0m	
6	Solder Ability Test	Temperature: 245°C±5°CDuration: 3.0s5.0sDepth: DIP2/3 , SMD1/5	
7	Resistance to Soldering Heat		

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